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Bib Data Sheet

<b>SERIAL NUMBER</b> 09/687,524	<b>FILING DATE</b> 10/12/2000 <b>RULE</b> -	<b>CLASS</b> 228	<b>GROUP ART UNIT</b> 1725	<b>ATTORNEY DOCKET NO.</b> END-00-0034US1
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## APPLICANTS

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\*\* CONTINUING DATA \*\*\*\*\*

none JJ

\*\* FOREIGN APPLICATIONS \*\*\*\*\*

none JJ

IF REQUIRED, FOREIGN FILING LICENSE  
GRANTED \*\* 11/16/2000

Foreign Priority claimed <input type="checkbox"/> yes <input checked="" type="checkbox"/> no	STATE OR COUNTRY NY	SHEETS DRAWING 1	TOTAL CLAIMS 32	INDEPENDENT CLAIMS 2
35 USC 119 (a-d) conditions met <input type="checkbox"/> yes <input checked="" type="checkbox"/> no <input type="checkbox"/> Met after Allowance				
Verified and Acknowledged Examiner's Signature: <i>[Signature]</i> Initials: <i>[Initials]</i>				

## ADDRESS

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## TITLE

Solder protective coating and fluxless joining of flip chip devices on laminates with plated solder

<b>FILING FEE RECEIVED</b> 926	FEES: Authority has been given in Paper No. _____ to charge/credit DEPOSIT ACCOUNT No. _____ for following:	<input type="checkbox"/> All Fees
		<input type="checkbox"/> 1.16 Fees ( Filing )
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